

### In the Claims

The following listing of the claims replaces all previous listings.

1.-29. (Canceled)

30. (Currently Amended) A compression molding composition for use in compression molding an article, said composition comprising:

in the range of greater than 0 to less than or equal to about 25 % by wt. inorganic fiber;

in the range of about 10 to 40 % by wt. inorganic binder suspended in an aqueous solution;

in the range of about 15 to 45 % by wt. carrier solvent; and

in the range of about 0 to 70 % by wt. additional additives.

31. (Canceled)

32. (Currently Amended) The composition of claim 30, wherein the additional additives include[[s]] an inorganic filler, and the inorganic filler is in the range of 15 to 70 % by weight of the total composition.

33. (Currently Amended) The composition of claim 30, wherein the additional additives include[[s]] an organic polymer, and the organic polymer is in the range of 0.1 to 0.5 % by weight of the total composition.

34. (Original) The composition of claim 33, wherein the organic polymer is an acrylic polymer.

35. (Currently Amended) The composition of claim 33, wherein the organic polymer acts as a molding thickener to help the composition hold shape when it is being molded.

36. (Original) The composition of claim 30, wherein the carrier solvent is water.

37. (Original) The composition of claim 36, wherein the composition has a moisture content in the range of 20 to 35% by weight of the total composition.

38. (Original) The composition of claim 37, wherein the composition has a moisture content 23 to 30% by weight of the total composition.

39. (Original) The composition of claim 38, wherein the composition has a moisture content in the range of 25 to 27% by weight of the total composition.

40. (New) The composition of claim 30, wherein the inorganic binder is colloidal silica.